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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/709,568	05/14/2004	Anchor Chen	NAUP0486USA4	3567
27765 75	590 05/03/2006		EXAMINER	
NORTH AMERICA INTELLECTUAL PROPERTY CORPORATION			LUU, CHUONG A	
P.O. BOX 506 MERRIFIELD, VA 22116		ART UNIT	PAPER NUMBER	
MERICITED,	VA 22110		2818	
			DATE MAILED: 05/03/2006	5

Please find below and/or attached an Office communication concerning this application or proceeding.

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Application No. Applicant(s) CHEN, ANCHOR 10/709,568 Office Action Summary **Art Unit** Examiner Chuong A. Luu 2818 -- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --**Period for Reply** A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 03 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b). **Status** 1) Responsive to communication(s) filed on _____. 2a) This action is **FINAL**. 2b) This action is non-final. Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213. **Disposition of Claims** 4) \boxtimes Claim(s) <u>1-27</u> is/are pending in the application. 4a) Of the above claim(s) _____ is/are withdrawn from consideration. 5) Claim(s) _____ is/are allowed. 6) Claim(s) <u>1-27</u> is/are rejected. 7) Claim(s) _____ is/are objected to. 8) Claim(s) ____ are subject to restriction and/or election requirement. **Application Papers** 9) The specification is objected to by the Examiner. 10) The drawing(s) filed on ____ is/are: a) accepted or b) objected to by the Examiner. Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152. Priority under 35 U.S.C. § 119 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) ☐ All b) ☐ Some * c) ☐ None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. _____. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. Attachment(s) Interview Summary (PTO-413) 1) Notice of References Cited (PTO-892) Paper No(s)/Mail Date. _____. 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 5) Notice of Informal Patent Application (PTO-152) 3) M Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) 6) U Other: ____. Paper No(s)/Mail Date <u>12/01/2004</u>.

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DETAILED ACTION

PRIOR ART REJECTIONS

Statutory Basis

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

The Rejections

Claims 1-27 are rejected under 35 U.S.C. 102(e) as being anticipated by Chuang et al. (U.S. 20030096486 A1).

Chuang discloses a self-aligned bipolar transistor with

(1); (7); (14); (21) a substrate (300);

a dielectric layer formed on the substrate (300);

an opening (312) formed in the dielectric layer to expose a portion of the substrate (see Figure 3C);

a semiconductor layer (316) formed on a sidewall and a bottom of the opening (312), the semiconductor layer extending outside the opening and above the dielectric layer (see Figure 3D);

a spacer (314) formed on the semiconductor layer (316) to define a self-aligned emitter region in the opening (312);

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an emitter conductivity layer (318) being filled into the self-aligned emitter region, and a PN junction being formed between the emitter conductivity layer and the semiconductor layer (see Figure 3D)

a salicide layer (319) formed on the emitter conductivity layer (318) and on the portion of the semiconductor layer extending outside the opening and above the ielectric layer (see Figure 3I);

- (2) wherein the semiconductor layer comprises at least one material selected from a material group consisting of silicon epitaxy, GaAs, InP and AlGaAs (see paragraph [0025]);
- (3) further comprising a selective implant collector region formed in the substrate beneath the semiconductor layer (see Figures 3C-3I);
- (4) further comprising an extended conductivity layer formed on the dielectric layer to connect to the semiconductor layer (see Figures 3C-3I);
- (5) further comprising an oxide layer and a silicon nitride layer formed between the extended conductivity layer and the dielectric layer (see Figures 3C-3I);
- (6); (13); (27) wherein the extended conductivity layer is composed of polysilicon (see Figures 3C-3I);
- (8) further comprising a selective implant collector region formed in the substrate beneath the GaAs layer (see Figures 3C-3I); Ec9)..

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Chuong A. Luu whose telephone number is (571) 272-1902. The examiner can normally be reached on M-F (6:15-2:45).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David C. Nelms can be reached on (571) 272-1787. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Chuong Anh Luu Patent Examiner April 18, 2006